



### • General Description

It combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

### • Features

- AEC-Q101 Qualified
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

### • Application

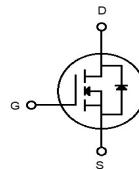
- BLDC Motor driver
- DC-DC
- Load Switch

### • Ordering Information:

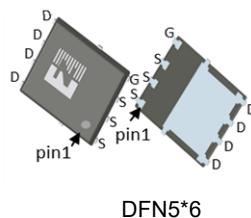
Part NO.	ZMSA009N06NC
Marking	ZMS009N06
Packing Information	REEL TAPE
Basic ordering unit (pcs)	3000

### • Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ , unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Max.	Unit
Drain-Source Voltage	$V_{DS}$		-	60	V
Gate-Source Voltage <sup>①</sup>	$V_{GS}$		-20	20	V
Continuous Drain Current	$I_D$	$V_{GS}=10\text{V}, T_C=25^\circ\text{C}$	-	384	A
	$I_D$	$V_{GS}=10\text{V}, T_C=75^\circ\text{C}$	-	313	A
	$I_D$	$V_{GS}=10\text{V}, T_C=100^\circ\text{C}$	-	271	A
Pulsed Drain Current <sup>①</sup>	$I_{DM}$	Pulsed; $t_p \leq 10\ \mu\text{s}; T_C = 25^\circ\text{C}$	-	1536	A
Total Power Dissipation	$P_D$	$T_C=25^\circ\text{C}$	-	224	W
Total Power Dissipation	$P_D$	$T_A=25^\circ\text{C}$	-	3.3	W
Operating Junction Temperature	$T_J$		-55	175	$^\circ\text{C}$
Storage Temperature	$T_{STG}$		-55	175	$^\circ\text{C}$
Single Pulse Avalanche Energy	$E_{AS}$	$L=0.1\text{mH}, V_{GS}=10\text{V}, R_g=25\Omega$ ,	-	605	mJ
		$L=0.3\text{mH}, V_{GS}=10\text{V}, R_g=25\Omega$ ,	-	968	mJ
ESD Level (HBM)			CLASS 2		



$V_{DS}= 60\text{V}$   
 $R_{DS(ON)} = 0.75\text{m}\Omega$   
 $I_D = 384\text{A}$



HF

**•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.67	°C/W
Thermal resistance, junction-ambient	R <sub>thJA</sub> <sup>(2)</sup>	-	-	45	°C/W
Soldering temperature	T <sub>sold</sub>	-	-	260	°C

**•Electronic Characteristics (T<sub>j</sub>=25°C,unless otherwise specified)**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60	-	-	V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA, T <sub>j</sub> =25°C	1.2	1.6	2.5	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =60V, T <sub>j</sub> =25°C	-	-	1	uA
Gate- Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> = 0V	-	-	100	nA
Static Drain-source On Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =40A, T <sub>j</sub> =25°C	-	0.75	0.9	mΩ
		V <sub>GS</sub> =10V, I <sub>D</sub> =40A, T <sub>j</sub> =175°C	-	1.3	-	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =32A, T <sub>j</sub> =25°C	-	1.2	1.5	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =32A, T <sub>j</sub> =175°C	-	2.0	-	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>SD</sub> = 10A	-	53	-	S
Diode Forward Voltage	V <sub>FSD</sub>	V <sub>GS</sub> =0V, I <sub>SD</sub> = 40A	-	-	1.3	V

**•Dynamic characteristics (T<sub>j</sub>=25°C,unless otherwise specified)**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input capacitance	C <sub>iss</sub>	f = 1MHz, V <sub>DS</sub> =30V, V <sub>GS</sub> =0V	-	6933	-	pF
Output capacitance	C <sub>oss</sub>		-	2263	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	179	-	
Gate Resistance	R <sub>g</sub>	f = 1MHz	-	1.1	-	Ω
Total gate charge	Q <sub>g</sub>	V <sub>DD</sub> = 30V,I <sub>D</sub> = 40A, V <sub>GS</sub> = 10V	-	152	-	nC
Gate - Source charge	Q <sub>gs</sub>		-	17	-	
Gate - Drain charge	Q <sub>gd</sub>		-	43	-	
Turn-ON Delay time	t <sub>D(on)</sub>	V <sub>GS</sub> =10V,V <sub>DS</sub> =30V,R <sub>G</sub> =3.3 Ω, I <sub>D</sub> =40A	-	18	-	ns
Turn-ON Rise time	t <sub>r</sub>		-	95	-	ns
Turn-Off Delay time	t <sub>D(off)</sub>		-	102	-	ns
Turn-Off Fall time	t <sub>f</sub>		-	131	-	ns
Reverse Recovery Time	t <sub>rr</sub>		-	64	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>S</sub> =40A	-	85	-	nC

Fig.1 Gate-source voltage as a function of gate charge;Typical values;T<sub>j</sub>=25°C

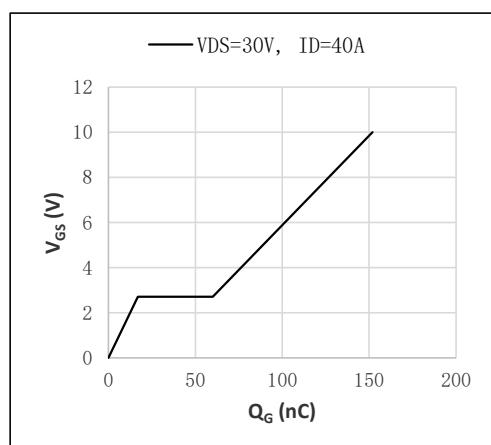


Fig.3 Output characteristics: drain current as a function of drain-source voltage;Typical values;T<sub>j</sub>=25°C

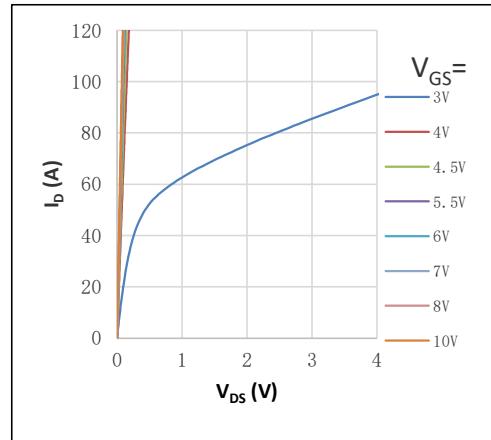


Fig.5 Gate-source threshold voltage as a function of junction temperature;Typical values

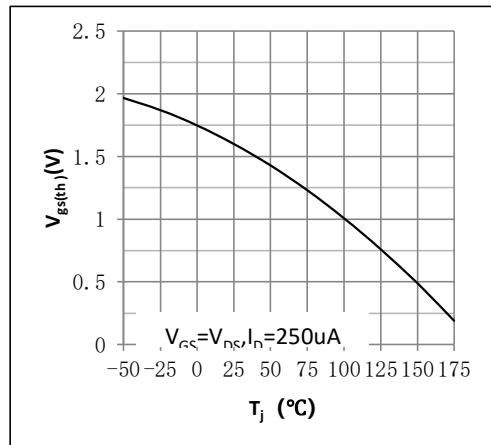


Fig.2 Input, output and reverse transfer capacitances as a function of drain-source voltage;Typical values;T<sub>j</sub>=25°C

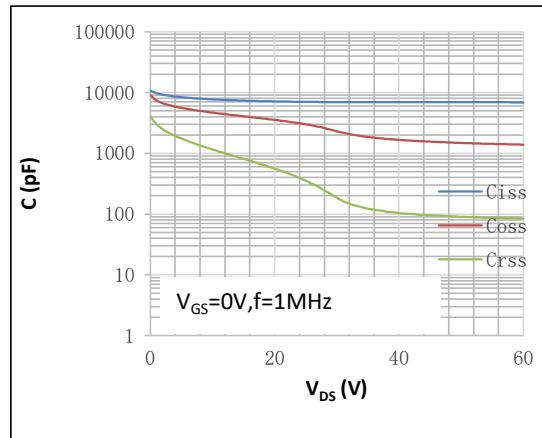


Fig.4 Output characteristics: drain current as a function of drain-source voltage;Typical values;Expanded curve;T<sub>j</sub>=25°C

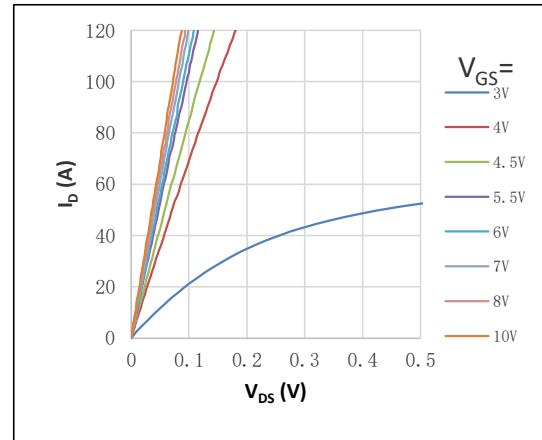


Fig.6 Drain-source on-state resistance as a function of drain current;Typical values;T<sub>j</sub>=25°C

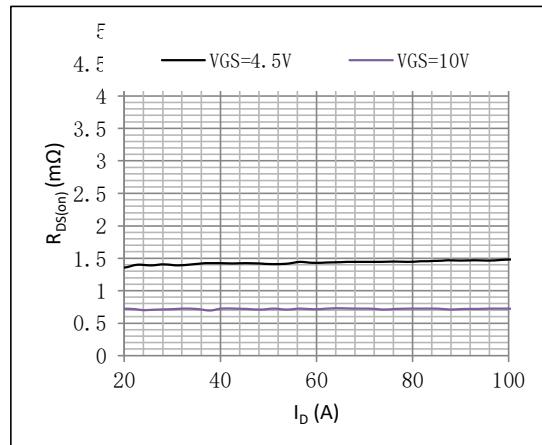


Fig.7 Drain-source on-state resistance as a function of gate-source voltage;Typical values

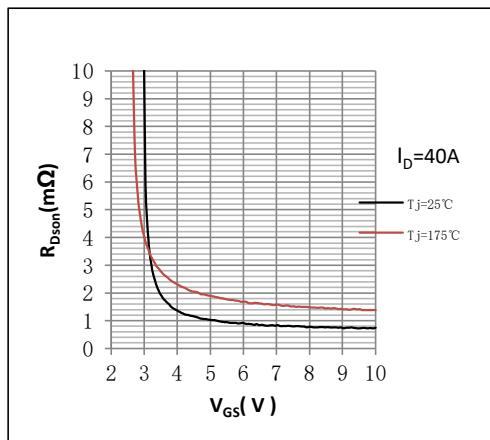


Figure 9. Source (diode forward) current as a function of source-drain (diode forward) voltage ;Typical values

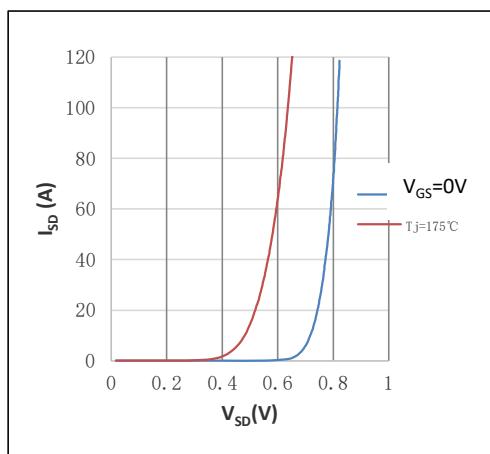


Fig.11 Safe operating area: continuous and peak drain currents as a function of drain-source voltage;Calculative values

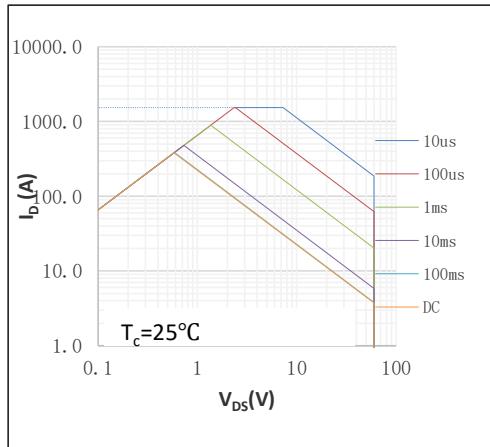


Fig.8 Normalized drain-source on-state resistance factor as a function of junction temperature;Typical values  
Normalized On-Resistance=RDSon/RDSon(25 °C)

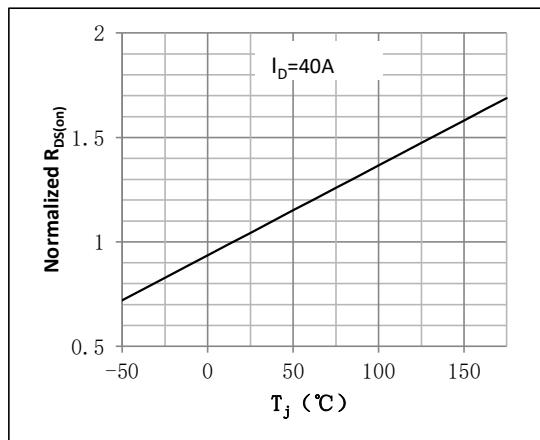


Figure 10. Transfer characteristics: drain current as a function of gate-source voltage;Typical values

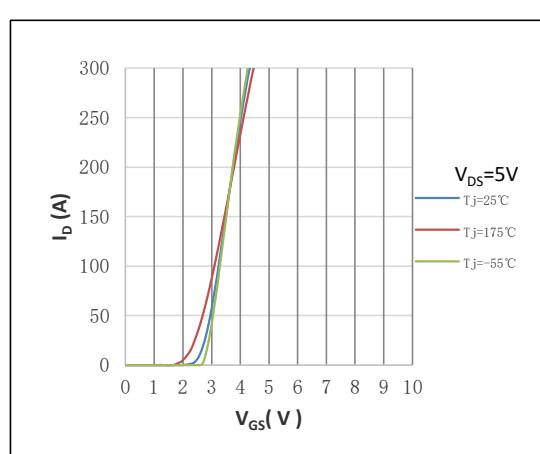


Fig.12 Continuous drain current as a function of case temperature<sup>③</sup>;Calculative values

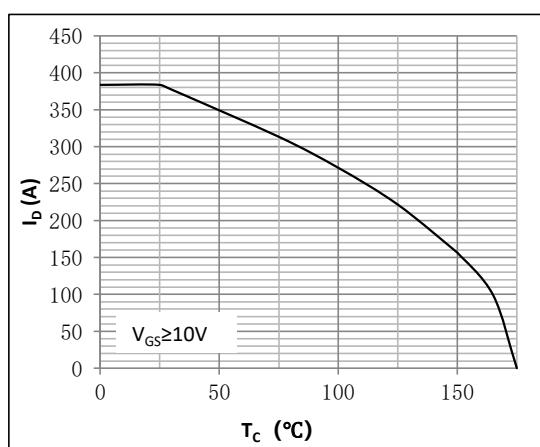


Fig.13 Drain-source breakdown voltage as a function of junction temperature;Typical values  
Normalized BVDSS=BVDSS/BVDSS(25°C)

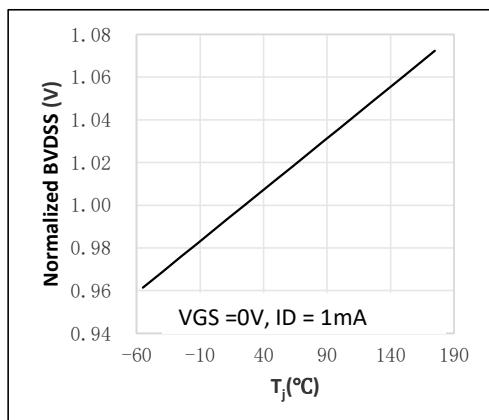


Fig.14 Normalized total power dissipation as a function of case temperature;Calculative values  
Normalized Power Dissipation=Pd/Pd(25°C)

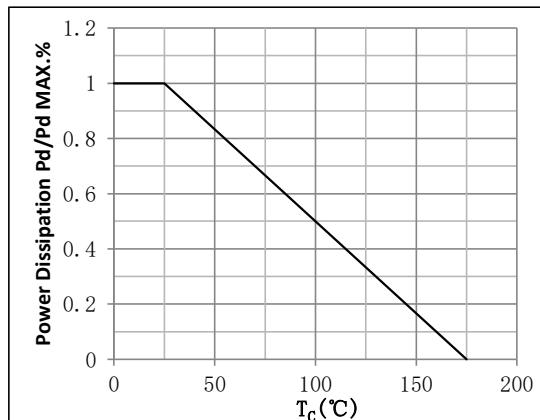
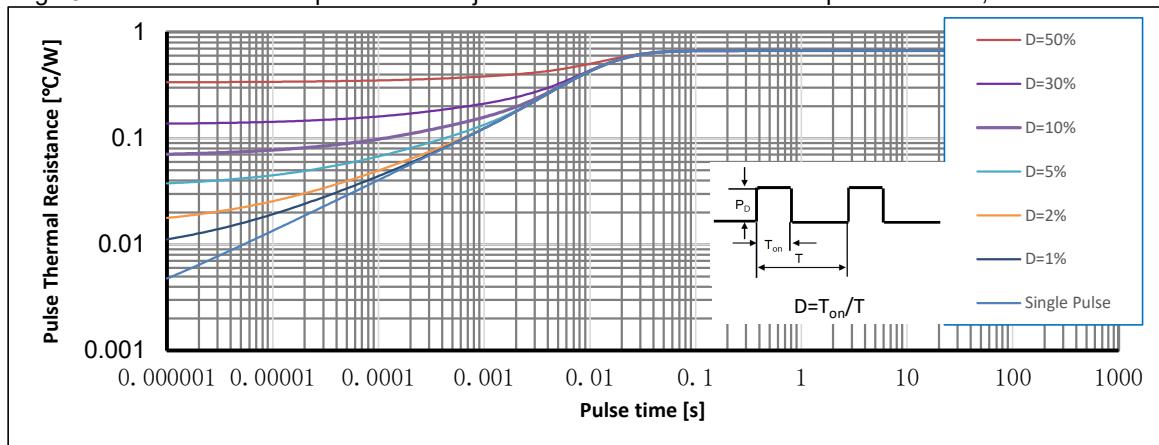
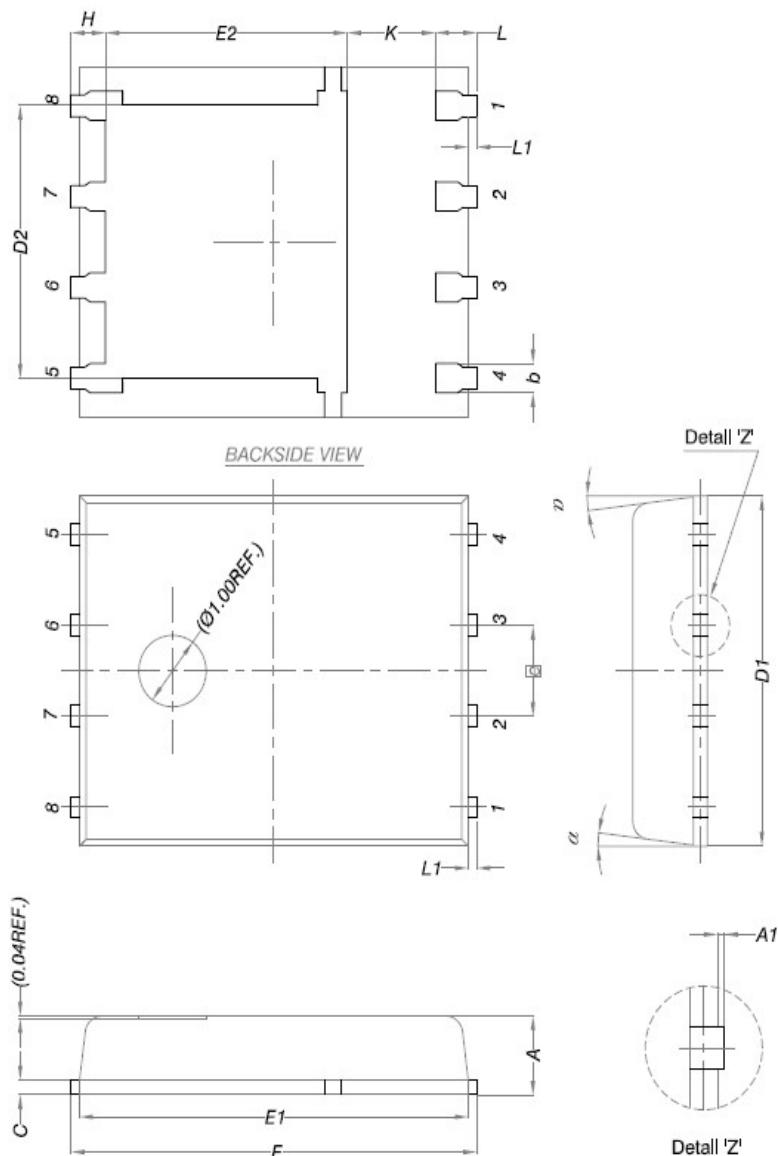


Fig.15 Transient thermal impedance from junction to case as a function of pulse duration; max values





## ●DFN5\*6 Package Outline



DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
A1	0	-	0.05
b	0.33	0.41	0.51
C	0.20	0.25	0.30
D1	4.80	4.90	5.00
D2	3.61	3.81	3.96
E	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.38	3.58	3.78
e	1.27 BSC		
H	0.41	0.51	0.61
K	1.10	-	-
L	0.51	0.61	0.71
L1	0.06	0.13	0.20
$\alpha$	0°	-	12°

**Note:**

- ① Pulse : VGS=+20V/-20V, Duty cycle=50%, Tj=175°C, t=1000 hours; For DC , the following test conditions can be passed: VGS=+20V/-10V, Tj=175°C, t=1000 hours;
- ② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;
- ③ Practically the current will be limited by PCB, thermal design and operating temperature. VGS=10V.

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Version	Date	Change
Preliminary	2024/11/12	New